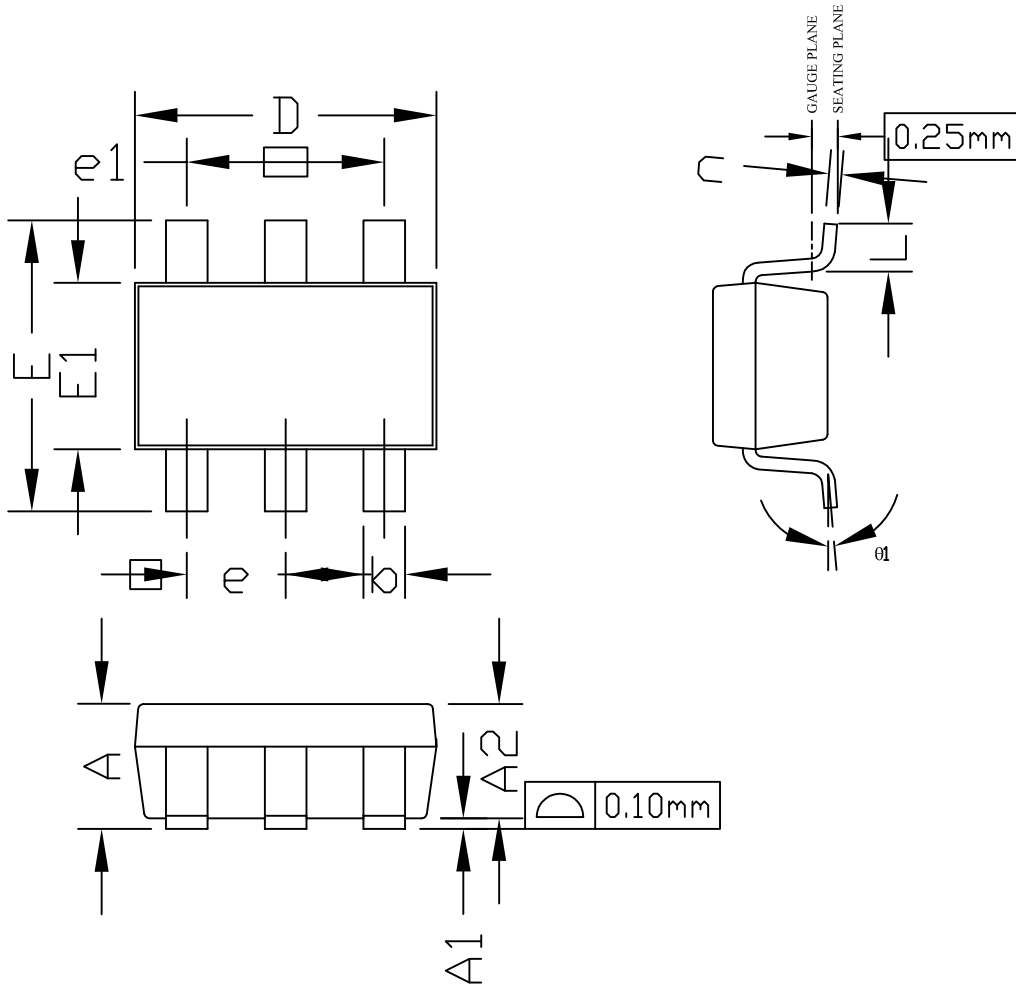
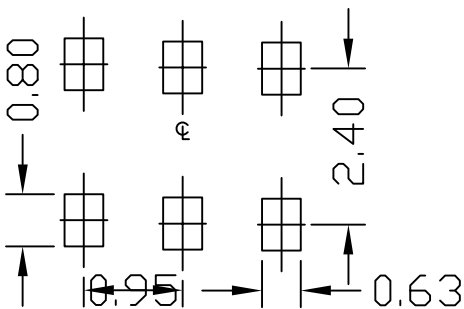


TSOP6 PACKAGE OUTLINE



RECOMMENDED LAND PATTERN



UNIT: mm

SYMBOLS	DIMENSIONS IN MILLIMETERS			DIMENSIONS IN INCHES		
	MIN	NOM	MAX	MIN	NOM	MAX
A	0.80	—	1.25	0.031	—	0.049
A1	0.00	—	0.15	0.000	—	0.006
A2	0.70	1.10	1.20	0.028	0.043	0.047
b	0.30	0.40	0.50	0.012	0.016	0.020
c	0.08	0.13	0.20	0.003	0.005	0.008
D	2.70	2.90	3.10	0.106	0.114	0.122
E	2.50	2.80	3.10	0.098	0.110	0.122
E1	1.50	1.60	1.70	0.059	0.063	0.067
e	0.95 BSC.			0.037BSC.		
e1	1.90 BSC.			0.075 BSC.		
L	0.30	—	0.60	0.012	—	0.024
$\theta 1$	0°	—	8°	0°	—	8°

NOTE

1. PACKAGE BODY SIZES EXCLUDE MOLD FLASH AND GATE BURRS.
MOLD FLASH AT THE NON-LEAD SIDES SHOULD BE LESS THAN 5 MILS EACH.
2. DIMENSION "L" IS MEASURED IN GAUGE PLANE.
3. TOLERANCE ± 0.100 mm (4 mil) UNLESS OTHERWISE SPECIFIED.
4. FOLLOWED FROM JEDEC MO-178C & MO-193C.
5. CONTROLLING DIMENSIONS IS MILLIMETER.
CONVERTED INCH DIMENSIONS ARE NOT NECESSARILY EXACT.

单击下面可查看定价，库存，交付和生命周期等信息

[>>AOS\(万国半导体\)](#)